

First	Name	Affiliation	1301	1303	1305	1307	1309	1311	1401
Yaseen	Al-Doori	Southern Methodist Univ.						X	
Jongsup	Baek	LG						X	
Gwen	Barriac	Qualcomm		X	X				
Harry	Bims	Bims Laboratory	X	X	X	X			
Daniel	Borges	Apple						X	X
Paul	Bottorff	HP							X
Woo-Jin	Byun	ETRI							X
George	Calcev	Huawei			X				
Ed	Callawah	Sonristo Micro Devices				X			
Radhakrishna	Canchi	Koyocera				X			
Fill	Carrey	Sony	X	X					
David	Castelow	Airspan		X					
Anthony	Chan	Huawei	X			X		X	
Xin	Chang	Huawei					X		
Paul	Congdon	Tallac Networks					X	X	X
Subir	Das	Applied Communication Science	X	X	X	X			
Thomas	Derham	Orange		X	X				
Marc	Emmelmann	Fraunhofer Focus		X	X				
Yonggang	Fang	ZTE		X	X	X	X	X	X
James	Gilb	Tensorcom							X
Tim	Godfrey	EPRI	X						
Nada	Golmie	NIST		X					
Daning	Gong	CATR		X					
Steve	Grau	Juniper		X					
Michael	Grigat	DTAG		X					
David	Halasz	Individual		X					
Jeffry	Handal	LSU						X	
Bob	Heile	ZigBee		X					
Ching-Tarng	Hsieh	ITRI	X	X	X	X			
Jen-Yuan	Hsu	ITRI			X				
Brian	Hugino	Taiyo Yaden	X						
Byun Jang	Jeong	ETRI							X
Seong Soon	Joo	ETRI	X	X					
Hyun Jeong	Kang	Samsung	X						
Hajime	Kanzaki	Hitachi Ltd		X					
John	Kenny	Toyota ITC		X					
Stuart J.	Kerry	OK-BRIT		X					
Farrokh	Khatibi	Qualcomm		X				X	
Per	Kinney	Kinney Consulting	X		X				
Funihide	Kojima	NICT							X
Jouni	Korhonen	Broadcom							X
Timo	Koskela	Renesas		X					
Bruce	Kraemer	Marvell				X			
Joe	Kwak	Interdigital			X				X
Laurent	Lariou	Orange	X						
Jean-Pierre	Le Rouzic	Orange	X	X	X	X			
Hyeong-Ho	Lee	ETRI	X	X		X	X	X	
Zander	Lei	I2R	X						
Josef	Levy	Interdigital	X						
Xingang	Liang	Huawei			X				
Yong	Liu	Apple			X				
Peter	Loc	Huawei	X						
Xiaobo	Long	Goldman Sachs					X		
Scott	Marin	NSN		X	X				
Roger	Marks	EthAirNet Assoc.	X	X	X	X	X	X	X

Stephen	Mccann	Blackberry	X				X		
Jordan	Melzer	TELUS	X						
Filip	Mestanov	Ericsson						X	
Fanny	Miinarsky	Octoscope		X					
Jim	Miller	Interdigital		X					
Bob	Miller	AT&T				X			
Apura	Mody	BAE Systems	X						
Michael	Montemurro	Blackberry	X	X	X	X	X	X	X
Ron	Murizs	Interdigital	X						
Chiu	Ngo	Samsung	X	X	X				
Christian	Niephaus	Fraunhofer					X		
Paul	Nikolich	IEEE 802 chair	X	X					
Yoshihiro	Ohba	Toshiba		X	X	X			
Antonio	Oliva, de la	UC3M					X		X
Hiro	Onishi	Alpine Electronics							X
Hyunho	Park	ETRI	X	X		X	X	X	
Xavier Costa	Perez	NEC		X		X			
Charlie	Perkins	Futurewei	X	X	X	X		X	
Lisa	Perry	IEEE SA						X	
Walter	Pienciak	IEEE SA		X	X	X		X	
Zei	Qin	CATT				X			
Demir	Rakanovic	U-Blox	X	X					
Harrish	Ramamurthy	Apple				X			
Stephen	Rayment	Ericsson	X			X			X
Edward	Reuss	Individual		X					
Max	Riegel	NSN	X	X	X	X	X	X	X
Dick	Roy	SRA				X	X	X	X
Kazuyuki	Sakoda	Sony		X					
Sam	Sambasivan	AT&T					X	X	
Peter Jeong	Sanykrown	IMRC					X		
Behcet	Sarikaya	Huawei						X	X
Ajay	Sigh	Apple				X			
Bo	Sun	ZTE		X					
Pat	Thaler	Broadcom							X
Ian	Timmins	Optical Cable Corporation				X			
Jens	Tingleff	Samsung	X						
Cha-Ling	Tsai	ITRI				X			
Korzuyoshi	Tsukada	Buffalo Inc	X	X					
Prabodh	Varshney	Nokia	X						
Diego	Vincentin	Princeton University						X	X
Chris	Walhuu	IDCC					X		
Lei	Wang	Interdigital		X	X				
Lisa	Ward	Rodhe & Schwarz	X	X					
Fuiro	Watanahe	Docomo Innovation	X						
Christopher	Williams	Ericsson		X	X	X			
Eric	Wong	Broadcom	X						
Harry	Worstell	AT&T		X					
Tao	Xing	Wuxi Sensingnet Institute							X
Akira	Yamada	NTT Docomo	X						
Xun	Yang	Huawei							X
Katsuo	Yunoki	KDDI Research		X					
Nader	Zein	NEC					X		
Guodong	Zhang	Interdigital		X					
Pei Ying	Zhu	Huawei				X			
Yan	Zhuang	Huawei	X					X	
Juan Carlos	Zuniga	Interdigital	X	X	X	X	X	X	X